

HV825

High-Voltage EL Lamp Driver IC

Features

- Processed with HVCMOS[®] Technology
- 1.0 to 1.6V Operating Supply Voltage
- · DC to AC Conversion
- · Output Load of Typically up to 6.0 nF
- Adjustable Output Lamp Frequency
- Adjustable Converter Frequency
- Enable Function

Applications

- · Pagers
- Portable Transceivers
- Cellular Phones
- Remote Control Units
- Calculators

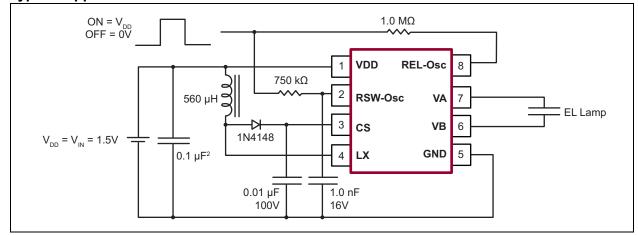
General Description

The HV825 is a high-voltage driver designed for driving EL lamps typically up to 6.0 nF. The input supply voltage range is from 1.0V to 1.6V. The device uses a single inductor and a minimum number of passive components. The typical output voltage that can be applied to the EL lamp is \pm 56V.

The HV825 can be enabled/disabled by connecting the R_{SW-Osc} resistor to V_{DD}/GND .

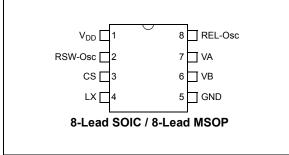
The HV825 has two internal oscillators to drive a switching bipolar junction transistor (BJT), and a high-voltage EL lamp driver. The frequency for the switching BJT is set by an external resistor connected between the R_{SW-Osc} pin and the V_{DD} supply pin. The EL lamp driver frequency is set by an external resistor connected between the R_{EL-Osc} pin and the V_{DD} pin. An external inductor is connected between the L_X and V_{DD} pins. A 0.01 to 0.1 μ F, 100V capacitor is connected between the C_S pin and the GND pin. The EL lamp is connected between the V_A pin and the V_B pin.

The switching BJT charges the external inductor and discharges it into the 0.01 to 0.1 μ F, 100V capacitor at the C_S pin. The voltage at the C_S pin will start to increase. The outputs V_A and V_B are configured as an H-bridge, and are switching in opposite states to achieve a peak-to-peak voltage of two times the V_{CS} voltage across the EL lamp.

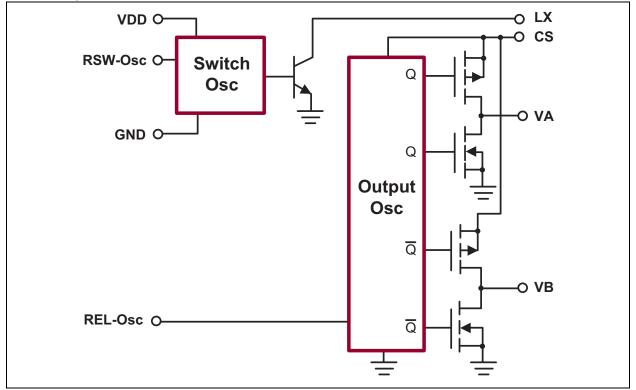


Typical Application Circuit

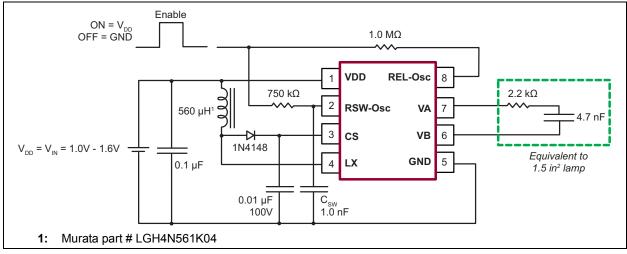
Package Types



Block Diagram



Test Circuit



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings^(†)

V _{DD} pin	0.5 to 2.5V
Package Power Dissipation (MSOP-8)	
Package Power Dissipation (SO-8)	400 mW
Operating Ambient Temperature Range	25°C to +85°C
Storage Temperature Range	65°C to +150°C

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure above maximum rating conditions for extended periods may affect device reliability

DC CHARACTERISTICS

Electrical Specifications: Unless otherwise specified, all specifications apply at T_A = 25°C over recommended operating conditions.

-F						
Parameters	Sym.	Min.	Тур.	Max.	Unit	Conditions
On-resistance of switching transistor	R _{ON}	—		15	Ω	l = 50 mA
V _{DD} supply current (including inductor current)	I _{IN}	_	30	38	mA	V_{DD} = 1.5V. See test circuit.
Quiescent V _{DD} supply current	I _{DDQ}	—	_	1.0	μA	R _{SW-OSC} = GND
Output voltage on V _{CS}	V _{CS}	52	56	62	V	V _{DD} = 1.5V. See test circuit.
Differential output voltage across lamp	V _{A-B}	104	112	124	V	V _{DD} = 1.5V. See test circuit.
V _{A-B} output drive frequency	f _{EL}	400	_	_	Hz	V _{DD} = 1.5V. See test circuit.
Switching transistor frequency	f _{SW}	—	30	—	KHz	V _{DD} = 1.5V. See test circuit.
Switching transistor duty cycle	D	—	88	_	%	
Recommended Operating Conditions						
Supply voltage	V_{DD}	1.0	_	1.6	V	
Load capacitance	CL	0	6	_	nF	
Operating temperature	T _A	-25	_	+85	°C	
Enable/Disable Table						
Low-level input voltage to R _{SW-OSC} resistor	V _{IL}	0	_	0.2	V	V _{DD} = 1.0–1.6V
High-level input voltage to R _{SW-OSC} resistor	V _{IH}	V _{DD} -0.5		V _{DD}	V	V _{DD} = 1.0–1.6V

Typical Thermal Resistance

Package	Θ _{ja}				
8-Lead SOIC	101°C/W				
8-Lead MSOP	216°C/W				

2.0 APPLICATION INFORMATION

2.1 Typical Performance

Table 2-1shows the performance of the typicalapplication circuit.

Lamp Size	V _{IN}	I _{DD}	v _{cs}	f _{EL}	Brightness				
1.5 in ²	1.5V	30 mA	56V	450 Hz	3.65 ft-Im				
Note: Results use Murata part # LQH4N561K04, max DC resistance = 14.5Ω									

TABLE 2-1: TYPICAL PERFORMANCE

2.2 Diode

A fast reverse recovery diode is used (1N4148 or equivalent).

2.3 C_S Capacitor

A 0.01 to 0.1 $\mu\text{F},$ 100V capacitor to GND is used to store the energy transferred from the inductor.

2.4 R_{EL-Osc} Resistor

The lamp frequency is controlled via the R_{EL-Osc} pin. The lamp frequency increases as R_{EL-Osc} decreases. As the lamp frequency increases, the amount of current drawn from the battery will increase and the output voltage V_{CS} will decrease. This is because the lamp will draw more current from V_{CS} when driven at higher frequencies.

In general, as the lamp size increases, a larger $R_{EL\text{-}Osc}$ is recommended to provide higher $V_{CS}.$ However, the color of the lamp is dependent upon its frequency and the shade of the color will change slightly with different frequencies.

2.5 R_{SW-Osc} Resistor

The switching frequency of the inductor is controlled via the R_{SW-Osc} . The switching frequency increases as the R_{SW-Osc} decreases. As the switching frequency increases, the amount of current drawn from the battery will decrease and the output voltage V_{CS} will also decrease.

2.6 L_X Inductor

The inductor L_X is used to boost the low input voltage. When the internal switch is on, the inductor is being charged. When the internal switch is off, the charge in the inductor will be transferred to the high voltage capacitor C_S . The energy stored in the capacitor is connected to the internal H-bridge and therefore to the lamp. In general, smaller value inductors, which can handle more current, are more suitable to drive larger lamps. As the inductor value decreases, the switching frequency of the inductor (controlled by R_{SW-Osc}) should be increased to avoid saturation.

The test circuit uses a Murata (LQH4N561) 560 μ H inductor. Using different inductor values or inductors from different manufacturers will affect the performance.

As the inductor value decreases, smaller R_{SW-Osc} values should be used. This will prevent inductor saturation. An inductor with the same inductance value (560 μ H) but lower series resistance will charge faster.

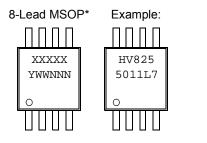
The $R_{SW\text{-}Osc}$ resistor value needs to be decreased to prevent inductor saturation and high current consumption.

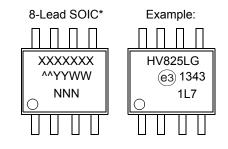
2.7 C_{SW} Capacitor

A 1 nF capacitor is recommended from the R_{SW-Osc} pin to GND. This capacitor is used to shunt any switching noise that may couple into the R_{SW-Osc} pin. A C_{SW} larger than 1 nF is not recommended.

3.0 PACKAGING INFORMATION

3.1 Package Marking Information

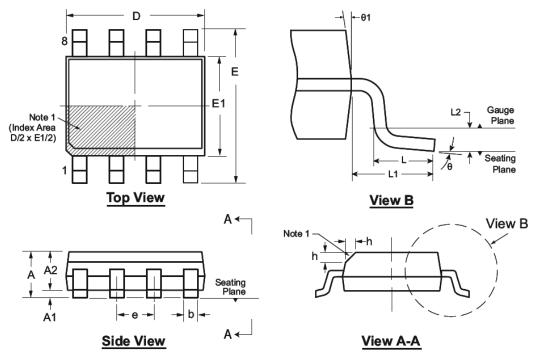




Legen	d: XXX Y YY WW NNN @3 *	Product Code or Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
Note:	be carrie characters	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for product code or customer-specific information. Package may or e the corporate logo.

8-Lead SOIC (Narrow Body) Package Outline (LG/TG)

4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging

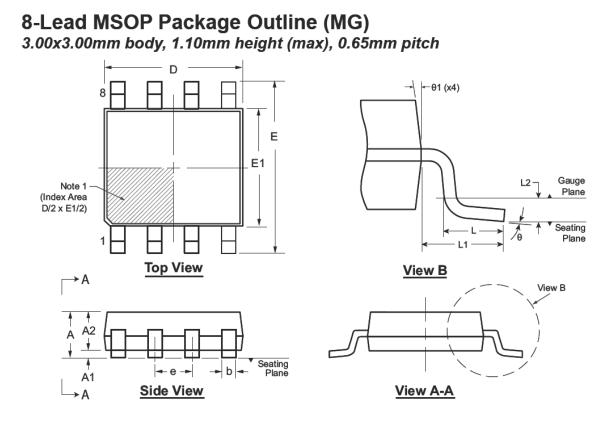
Note:

This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be; a molded mark/identifier; 1. an embedded metal marker; or a printed indicator.

Symbo	I	А	A1	A2	b	D	E	E1	e	h	L	L1	L2	θ	θ1
	MIN	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*		0.25	0.40			0 0	5 ⁰
Dimension (mm)	NOM	-	-	-	-	4.90	6.00	3.90	1.27 BSC	-	-	1.04 REF	0.25 BSC	-	-
()	MAX	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*	500	0.50	1.27		200	8 0	15 ⁰

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005. * This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Note:

1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	ol	А	A1	A2	b	D	E	E1	е	L	L1	L2	θ	θ1
	MIN	0.75*	0.00	0.75	0.22	2.80*	4.65*	2.80*		0.40			0 0	5 ⁰
Dimension (mm)	NOM	-	-	0.85	-	3.00	4.90	3.00	0.65 BSC	0.60	0.95 REF	0.25 BSC	-	-
()	MAX	1.10	0.15	0.95	0.38	3.20*	5.15*	3.20*	200	0.80		200	8 0	15 ⁰

JEDEC Registration MO-187, Variation AA, Issue E, Dec. 2004.

* This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

APPENDIX A: REVISION HISTORY

Revision A (November 2015)

• Initial release of this document in the Microchip format. This replaces version CO72913.

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	XX Package Options	– Envir	X ∏ ronmental	_ X Media Type	9	Examples: a)HV825LG-G:	High Voltage EL Lamp Driver IC 8-lead SOIC package, 2500/reel
Device:	HV825	= High	Voltage EL Lamp	Driver IC		b)HV825MG-G:	High Voltage EL Lamp Driver IC 8-lead MSOP package, 2500/reel
Package:	LG MG		d SOIC d MSOP				
Environmental:	G	= Lead	(Pb)-free/ROHS	-compliant Package			
Media Type:	(blank)	= 2500	/Reel for LG and	MG packages			

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, flexPWR, JukeBlox, KEELOQ, KEELOQ logo, Kleer, LANCheck, MediaLB, MOST, MOST logo, MPLAB, OptoLyzer, PIC, PICSTART, PIC³² logo, RightTouch, SpyNIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

The Embedded Control Solutions Company and mTouch are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, ECAN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, KleerNet, KleerNet logo, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, RightTouch logo, REAL ICE, SQI, Serial Quad I/O, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2015, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

ISBN: 978-1-5224-0001-1

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEEL0Q® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and mulfacture of development systems is ISO 9001:2000 certified.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Cleveland Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110

Canada - Toronto Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway

Harbour City, Kowloon Hong Kong Tel: 852-2943-5100 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Dongguan Tel: 86-769-8702-9880

China - Hangzhou Tel: 86-571-8792-8115 Fax: 86-571-8792-8116

China - Hong Kong SAR Tel: 852-2943-5100 Fax: 852-2401-3431

China - Nanjing Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian Tel: 86-29-8833-7252 Fax: 86-29-8833-7256 ASIA/PACIFIC

China - Xiamen Tel: 86-592-2388138 Fax: 86-592-2388130

China - Zhuhai Tel: 86-756-3210040 Fax: 86-756-3210049

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-3019-1500

Japan - Osaka Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7828

Taiwan - Taipei Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Dusseldorf Tel: 49-2129-3766400

Germany - Karlsruhe Tel: 49-721-625370

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Venice Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Poland - Warsaw Tel: 48-22-3325737

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

07/14/15

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Display Drivers & Controllers category:

Click to view products by Microchip manufacturer:

Other Similar products are found below :

ICB2FL01G HV5812PJ-G-M904 TW8813-LB2-GR TW8811-PC2-GR MAX1839EEP+ TW9907-TA1-GR LX27901IDW SSD2828QN4 ICB2FL01GXUMA2 DLP2000FQC PAD1000YFFR S1D13746F01A600 FIN324CMLX AD8387JSVZ DLPC6421ZPC HV852K7-G HV859K7-G HV857K7-G DI02133CT14 S1D13506F00A200 S1D13L03F00A100-40 TW2836-BA1-GR SSD2829QL9 MAX749CSA+T MAX4820EUP+T ICL7135CAI+ ICL7135CMH+D ICL7137CMH+D MAX25221BATJ/V+ S1D13748B00B100 S1D13A05B00B200 MAX3738ETG+T MAX8722CEEG+ MAX749CPA+ MAX8785AETI+ ICL7135CQI+ HV518PJ-G-M903 HV5812P-G HV5812PJ-G HV7224PG-G HV853K7-G HV860K7-G HV6810WG-G HV823LG-G HV857MG-G HV833MG-G HV857LMG-G HV859MG-G FMS6363ACSX FMS6364AMTC14X